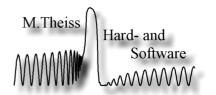
M.Theiss Hard- and Software for Optical Spectroscopy Dr.-Bernhard-Klein-Str. 110, D-52078 Aachen Phone: (49) 241 5661390 Fax: (49) 241 9529100 E-mail: theiss@mtheiss.com Web: www.mtheiss.com



# Developing optical production control methods for SCOUT

by Wolfgang Theiss

All rights reserved. No parts of this work may be reproduced in any form or by any means - graphic, electronic, or mechanical, including photocopying, recording, taping, or information storage and retrieval systems - without the written permission of the publisher.

Products that are referred to in this document may be either trademarks and/or registered trademarks of the respective owners. The publisher and the author make no claim to these trademarks.

While every precaution has been taken in the preparation of this document, the publisher and the author assume no responsibility for errors or omissions, or for damages resulting from the use of information contained in this document or from the use of programs and source code that may accompany it. In no event shall the publisher and the author be liable for any loss of profit or any other commercial damage caused or alleged to have been caused directly or indirectly by this document.

Printed: 04.11.2003, 15:36 in Aachen, Germany

# **Table of Contents**

	Foreword	2
Part I	Overview	3
1	Title	3
2	Introduction	4
Part II	Preliminary actions	5
1	Gathering information	5
2	Selecting the appropriate method	6
3	First test measurements and rough optical modelling	6
	Systematic test measurements	
Part III	Development of the optical model	9
1	Optical constants	9
	Interband transitions	11
	Vibrational modes	13
	Charge carriers	
	Master model	-
	'Rules of thumb' Substance A: Test oxide model	
	Substance A: Test oxide model	-
2	Layer structure	
	Fit strategy	
Part IV	Final actions	30
1	Integration into the customer's environment	30
2	Company tests and long-time support	32
	Index	0

# Foreword

This document gives a short summary of several talks and documents about spectrum simulation.

All the pictures are just screen shots, not prepared explicitly for this document. In between the pictures there are comments that should guide you from slide to slide.

Most of the slides in the talks are interactive pictures: You can vary slider positions and see what happens to the spectra. Unfortunately, in this static document these dynamical impressions cannot be reproduced.

In the graphs displaying optical constants the real part is drawn blue, the imaginary one is given in red.

In the case of spectrum fits, the measured spectra are always in red, the simulated spectra in blue.

All simulations have been performed with our SCOUT software which is commercially available.

Aachen, October 2003

# 1.1 Title

Developing optical production control methods for SCOUTW.TheissM.Theiss Hard- and Software

For a better understanding of people producing and analyzing thin films!

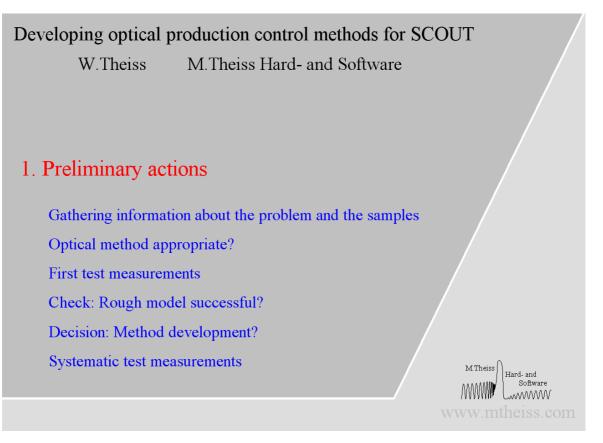
Content

- 1. Preliminary actions
- 2. Development of the optical model
- 3. Final actions

M.Theiss Hard- and Software

#### 1.2 Introduction

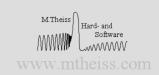
A short introductory rush through the three main steps of the presentation:



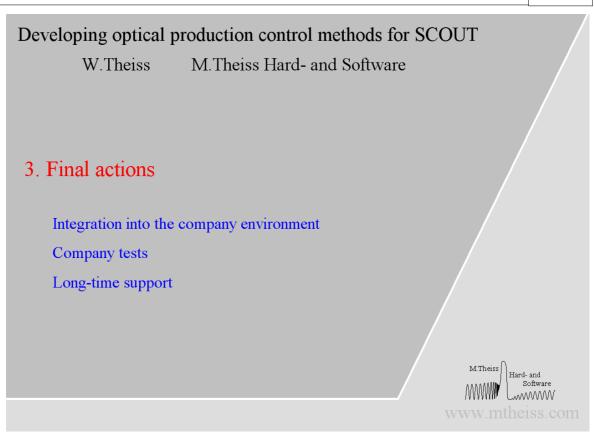
Developing optical production control methods for SCOUTW.TheissM.Theiss Hard- and Software

# 2. Development of the optical model

Selecting optical constant models Fixing the layer structure Fit strategy







# 2 Preliminary actions

## 2.1 Gathering information

Get information about the problem to be solved and the circumstances of the development:

1. Preliminary actions Gathering information about the problem and the samples

What is the problem?

Production conditions?

What kind of people will be using the method?

How fast should the method deliver results?

When should the method be finished?

How much money can you spend?

Developing optical production control methods for SCOUT

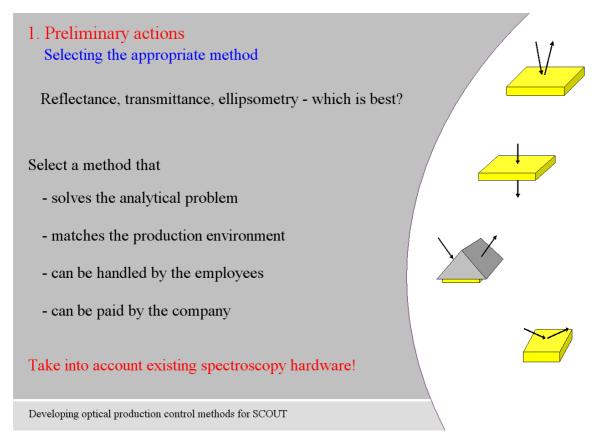






#### 2.2 Selecting the appropriate method

Considering the goal of the method and the external conditions, the appropriate experimental technique is selected:



## 2.3 First test measurements and rough optical modelling

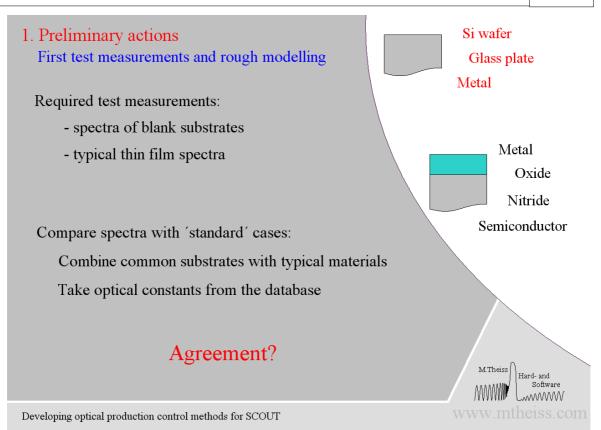
Do first test measurements: Investigate a blank substrate, and - if possible - a seris of thin film spectra covering the expected variety of cases in the production.

Verify that measured substrate spectra agree with simulated ones. This is an important check of the spectrometer hardware and the measurement procedure.

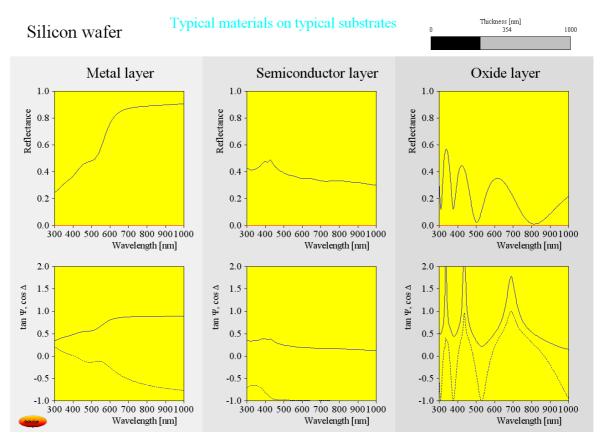
Can we successfully describe the thin film test measurements with preliminary, simple optical models?

Identify the type of material by comparison to known cases: Metal, semiconductor, oxide or nitride?



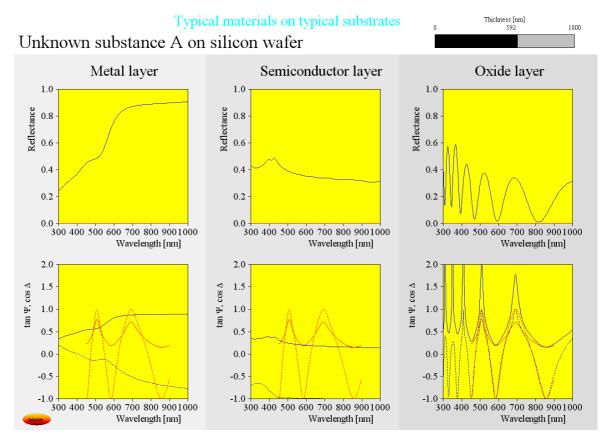


The following graphs show spectra of typical metal, semiconductor and oxide thin films on a silicon wafer substrate. The top pictures display the reflectance, the bottom ones show ellipsometry spectra:



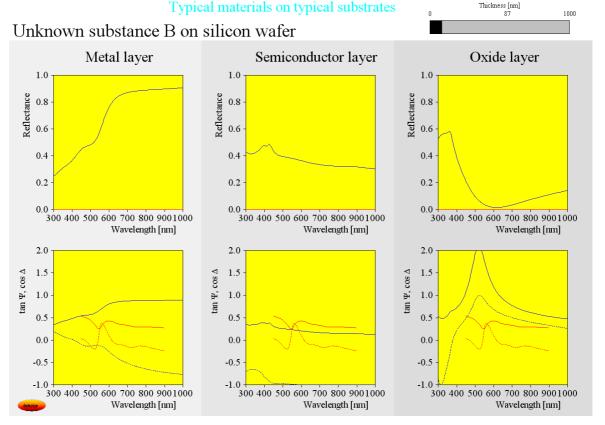
We now load measured ellipsometry data for an unknown substance on silicon. A rough comparison shows that the material behaves like a typical oxide. Very likely an adjustable 'oxide

model' will lead to a succesful simulation (this will be verified later on):



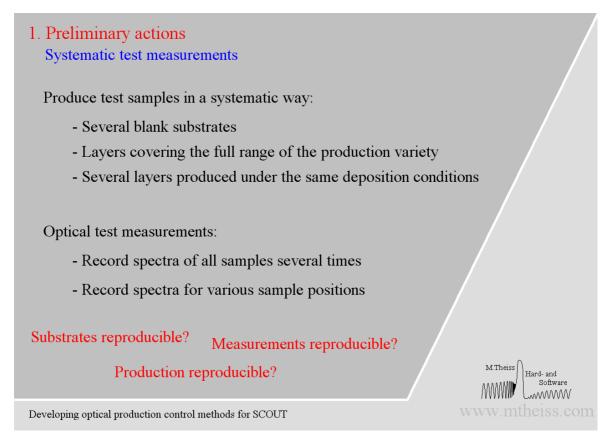
For another test material there is no convincing agreement with any of the typical cases. In this case a new type of optical constant model has to be developed:

Typical materials on typical substrates



#### 2.4 Systematic test measurements

In case of succesful pre-liminary tests: Decide to realize the method and continue with systematic test measurements.

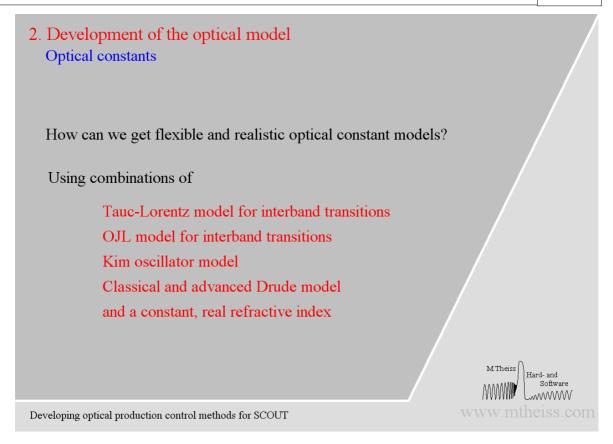


# **3** Development of the optical model

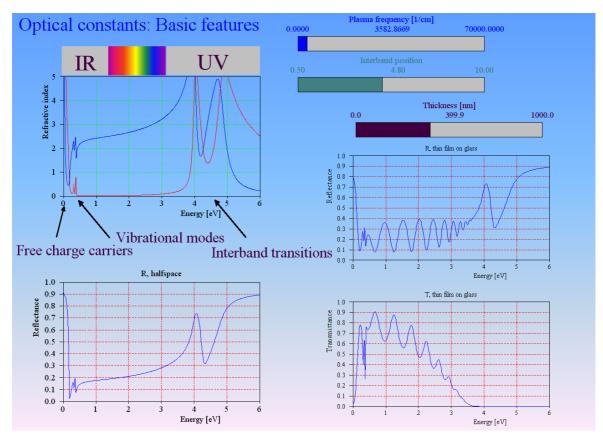
#### **3.1 Optical constants**

Having gathered enough information and data the optical model for the given analytical problem can be developed.

The basis of any spectrum simulation method are correct optical constants. In most cases of optical process control models with adjustable parameters are required.



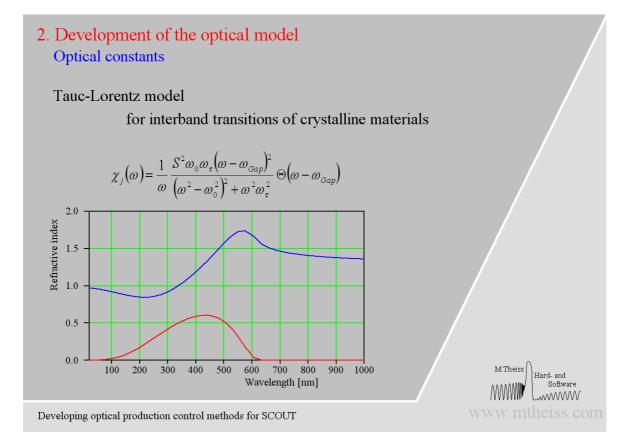
With these models we can successfully treat the three basic excitations: Interband transitions, vibrational modes and the acceleration of free charge carriers (electrons, holes).



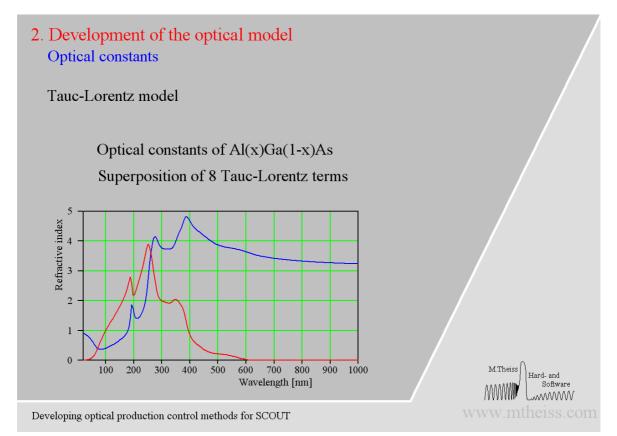
Models for the individual excitation types are suggested in the following sections.

#### 3.1.1 Interband transitions

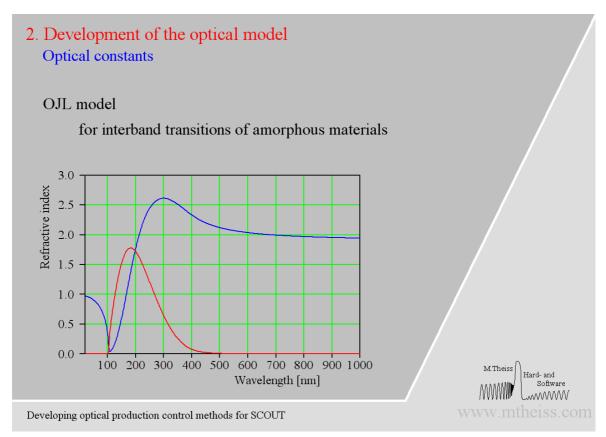
Interband transitions of cystalline materials can be descibed using the Tauc-Lorentz model:

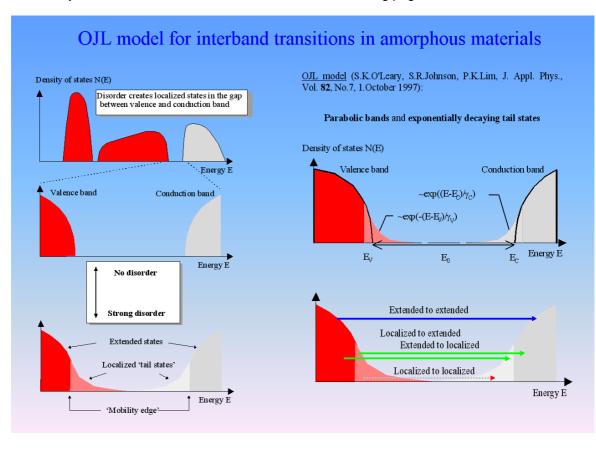


Here is a typical example using the superposition of 8 interband transitions:



Amorphous materials have less rich featured, broad interband transitions which can often be described in good quality using a single OJL model:

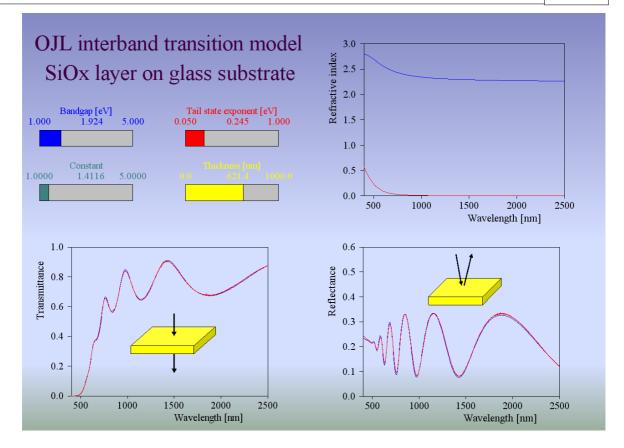




The theory behind the OJL model is summarized in the following page:

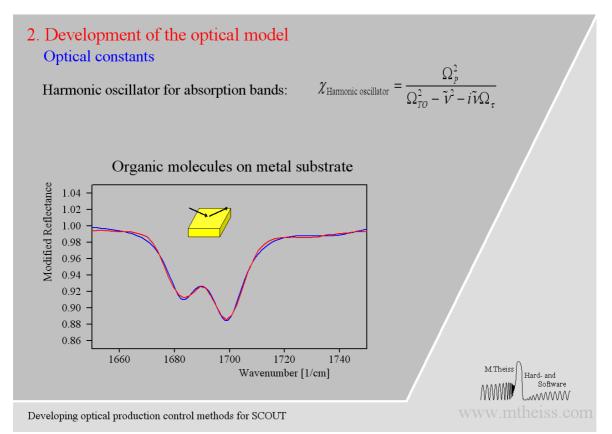
Here is an example of a succesful application of the OJL model:

12

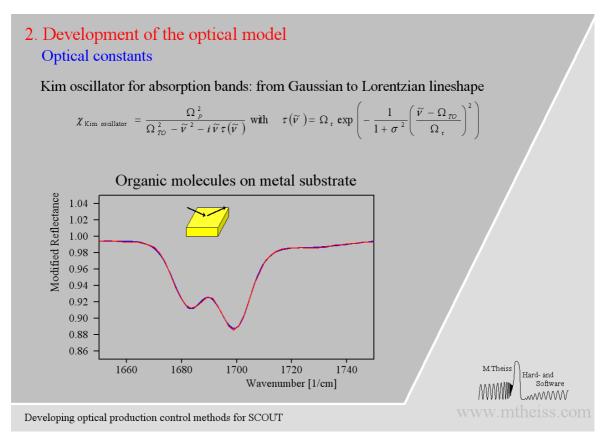


#### 3.1.2 Vibrational modes

Vibrational modes and some electronic interband transitions can be modeled using oscillator terms. The simplest approach is the harmonic oscillator which leads to a Lorentzian line shape of the absorption band:

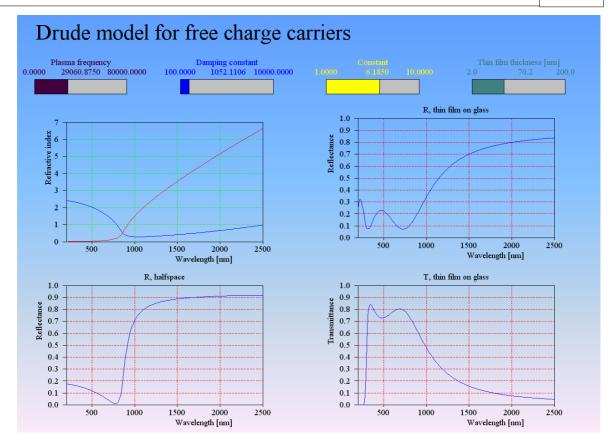


However, in most cases a Gaussian line shape is more realistic. In SCOUT this can be obtained using Kim oscillators:



#### 3.1.3 Charge carriers

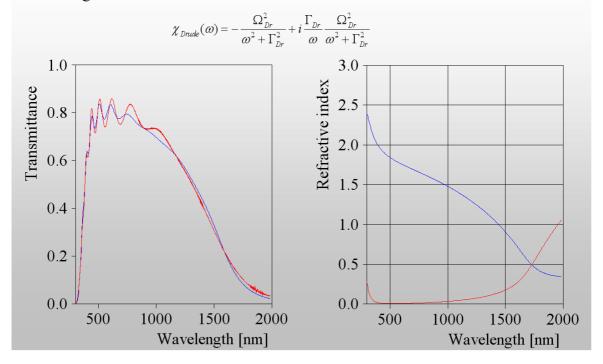
The interaction of free charge carriers like electrons or holes can be described with the Drude model. This model has two parameters only: The plasma frequency is proportional to the square root of the carrier density, the damping constant to the inverse of the mobility. Characteristic for the presence of many charge carriers (like in metals) is the large imaginary part of the refractive index. If it is larger than the real part, no wave propagation is possible in the material. This leads to a 'rejection' of incoming waves, i.e. to a high reflectance. Radiation penetrating a metal is absorbed very efficiently in a very thin film.



The following example shows that the simple Drude model does not always perform excellently:

# Drude model

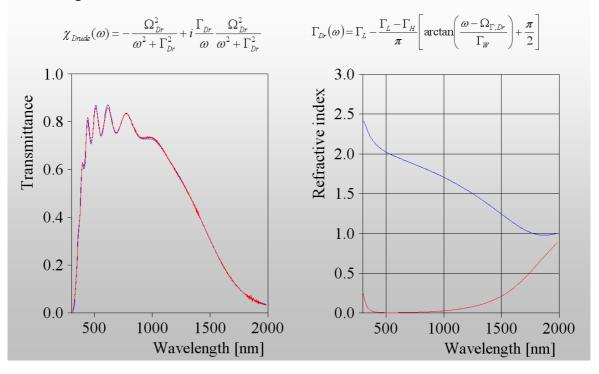
ITO on glass: constant + OJL interband transition + Drude model



In cases like this you can try an extension of the Drude model which features a frequencydependent damping constant. Electron scattering at charged donor or acceptor atoms may lead to a characteristic frequency dependence of the damping constant in the Drude model:

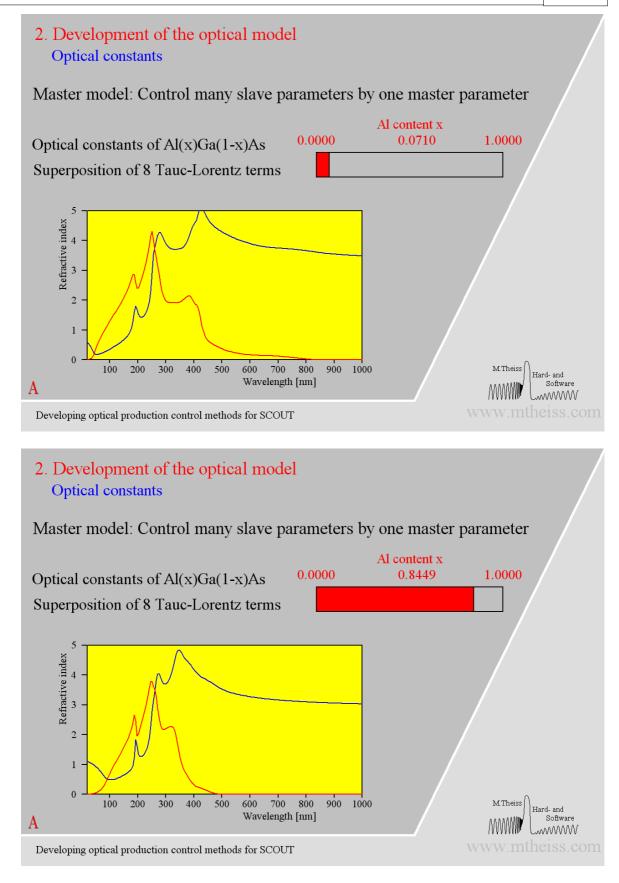
# Extended Drude model

ITO on glass: Constant + OJL interband transition + extended Drude model



#### 3.1.4 Master model

Sometimes the optical constants of a material vary systematically with a compositional parameter like oxygen content in a non-stochiometric oxide or the concentration of an atomic species in a ternary system. This can be described conveniently in SCOUT using so-called master models which provide for every parameter a user-defined formula to express its dependence on the master quantity:



#### 3.1.5 'Rules of thumb'

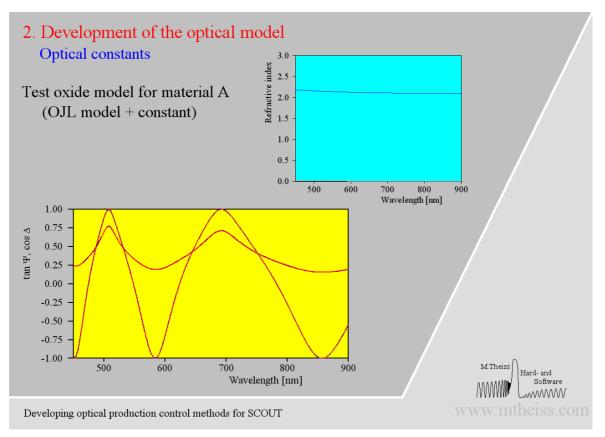
Use the following rules of thumb to find appropriate models for optical constants:

Material typeUse combination ofMetalTauc-Lorentz (or OJL), Drude, constantSemiconductor (cryst.)Tauc-Lorentz, Drude or ext. Drude, constantSemiconductor (amorph.)OJL, Drude or extended Drude, constantOut on the NitcideOH, constant	
Semiconductor (cryst.)Tauc-Lorentz, Drude or ext. Drude, constantSemiconductor (amorph.)OJL, Drude or extended Drude, constant	
Semiconductor (cryst.)Tauc-Lorentz, Drude or ext. Drude, constantSemiconductor (amorph.)OJL, Drude or extended Drude, constant	
Out 1 Minute OIL constant	
Oxide, Nitride OJL, constant	
Organic materials OJL, Kim, constant	
Unknown Unknown	

© 2003 Wolfgang Theiss

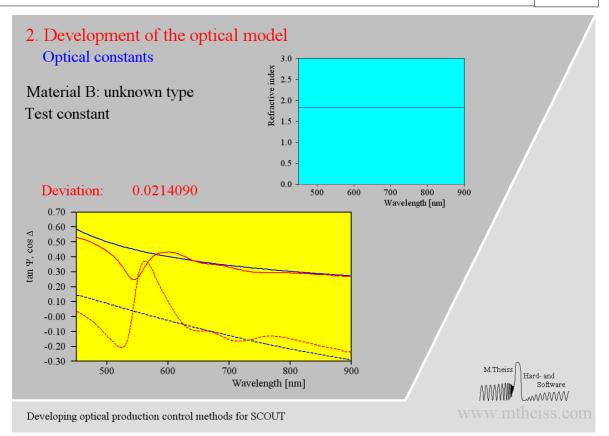
#### 3.1.6 Substance A: Test oxide model

The optical properties of the unknown substance A (see above) can be described easily using the suggested oxide model:

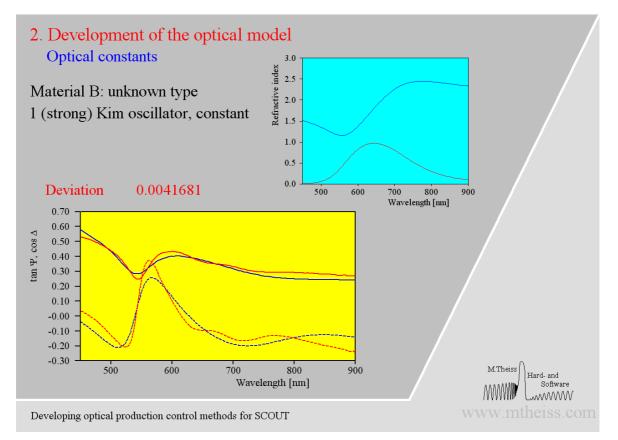


#### 3.1.7 Substance B: Develop a new model

None of the standard cases seemed to be applicable for substance B (see above). Hence we have to develop a new model from scratch. In the following we assume that the layer thickness is about 40 nm (let's assume that we have got this rough number from the producer). The simplest model would be just a constant. Varying the constant and the layer thickness the following 'agreement' of model and measurement is found:



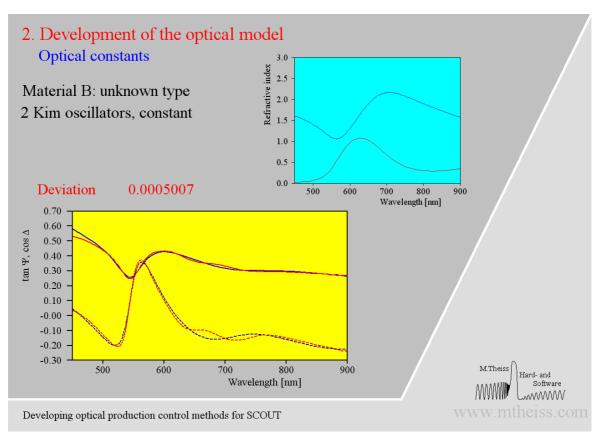
The spectral features do not look like interference fringes, so a rather strong dispersion of the refractive index and a strong absorption may be responsible for the observed structures. Test a strong Kim oscillator (combined with a constant):



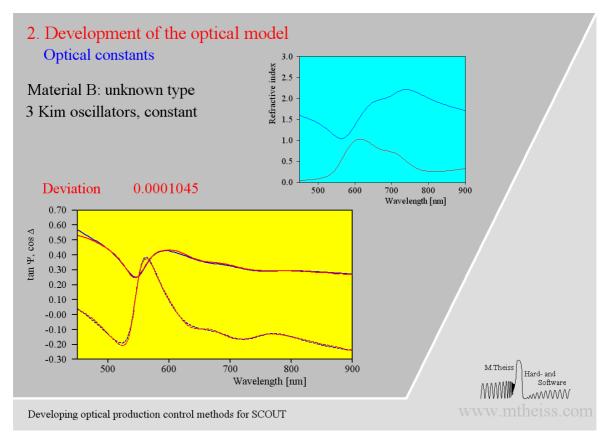
This looks promising. However, there are more structures in the measurement. Let's see if a second oscillator can help to improve the model. Although the second oscillator has been

20

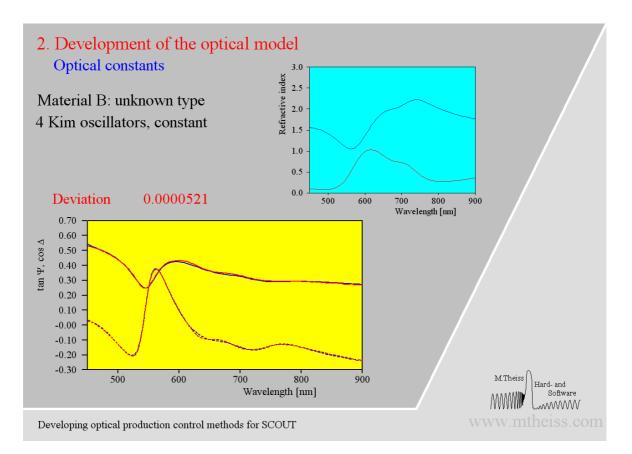
positioned around 750 nm initially, the fit algorithm moved it into the infrared in order to reduce the difference of model and measurement above 800 nm wavelength:



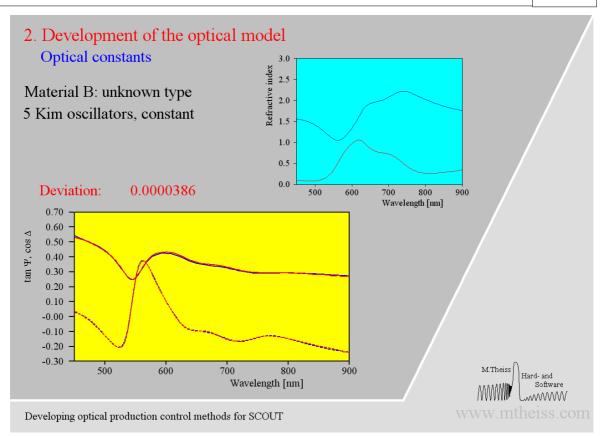
Still there is a large structural mismatch between 650 and 750 nm wavelength. Again, another Kim oscillator is introduced in order to fix this problem:



This is a real breakthrough. Only minor differences have to be removed. A Kim oscillator placed in the blue is now added which is going to improve the model for small wavelengths:



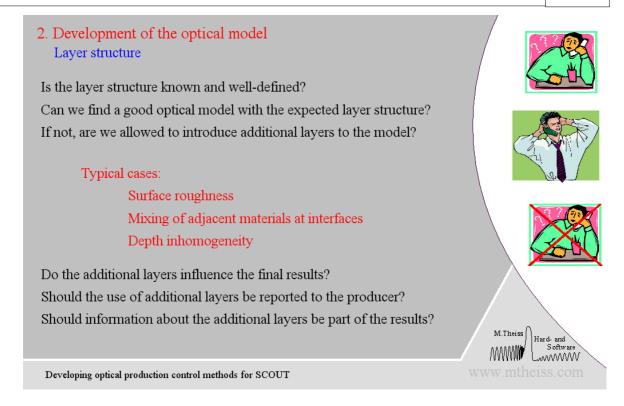
It's not easy to stop now because every additional oscillator turned out to be useful (and it seems to be a nice game). Let's do it one more time in the spectral range around 650 nm:



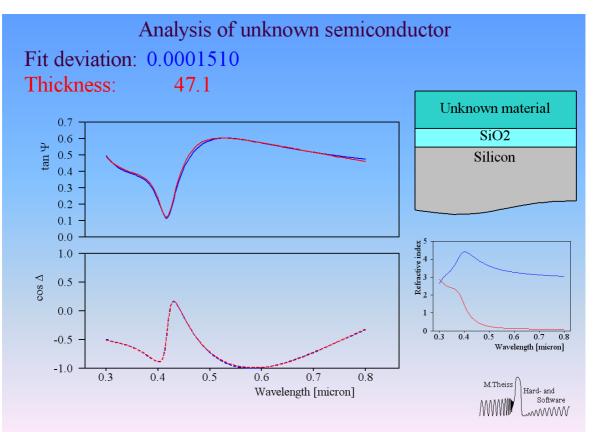
This seems to be good enough now. It would be important to check the obtained optical constants in other situtations. Other thicknesses could be prepared, and other substrates or different optical methods like reflectance or transmittance could be used in order to verify the validity of the result of the analysis.

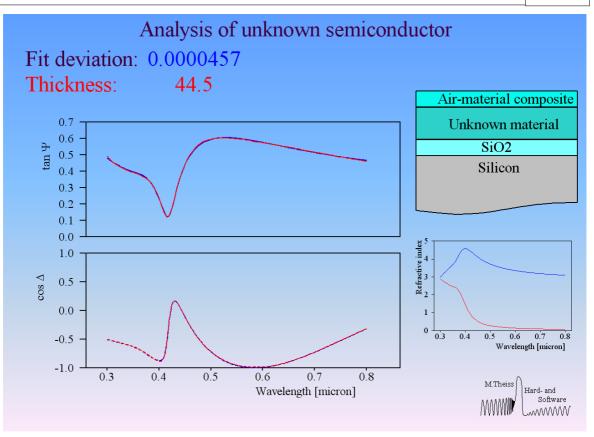
#### 3.2 Layer structure

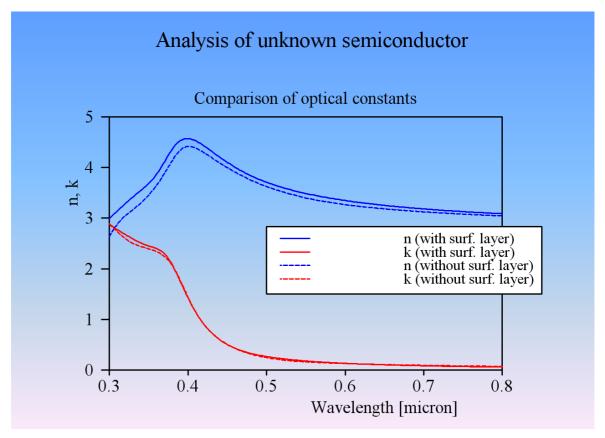
In addition to the setup of optical constant models (see above) the structure of the layer stack must be questioned in some cases. Often layers additional to the ones reported by the producer must be introduced.



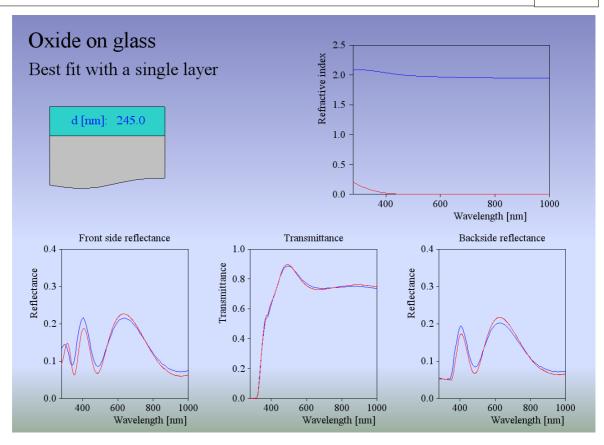
Example: The next graphs show the influence of the introduction of a surface layer to the results of a `single layer analysis´. It is not easy to decide if the differences are significant if the roughness is always the same. However, if the roughness changes from sample to sample it should definitely be part of the model and part of the exported results.



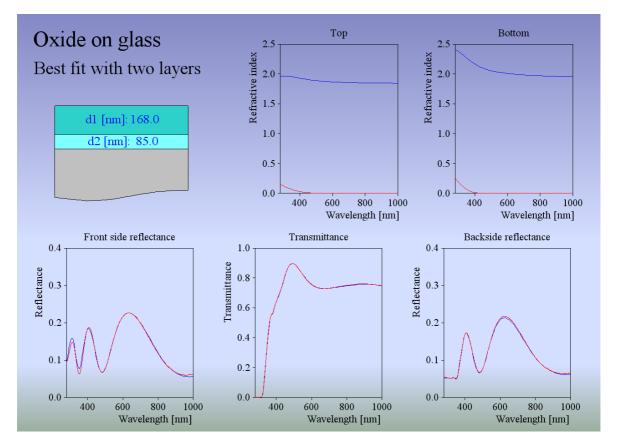




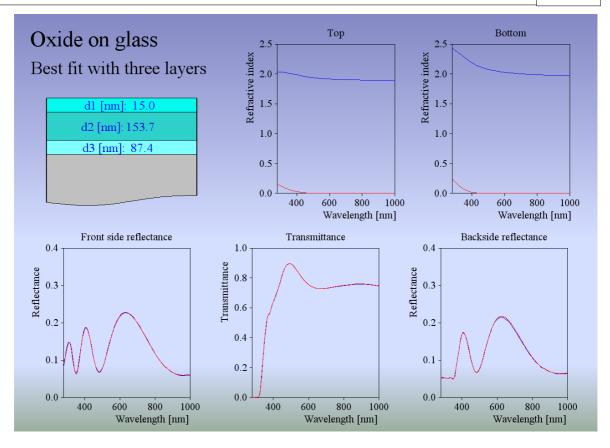
Here is another example: A customer asked for the optical constants of a single layer deposited on glass with a sputtering device. It turned out that even advanced optical constant models could not describe the optical properties of the layer properly.



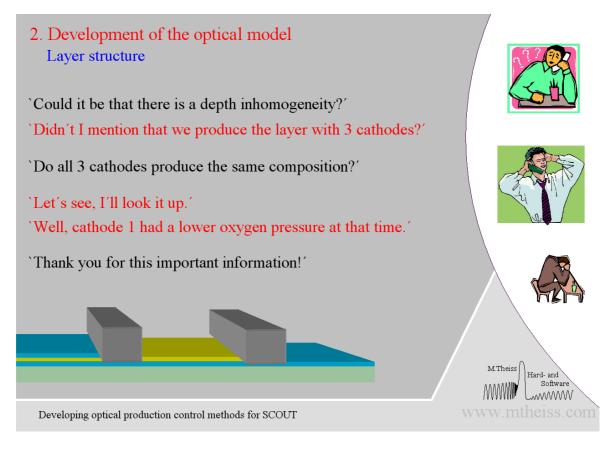
Only introducing a depth inhomogeneity (and a surface layer) could solve the problem:







Communication with the producer finally verified the assumptions made in the successful fit:



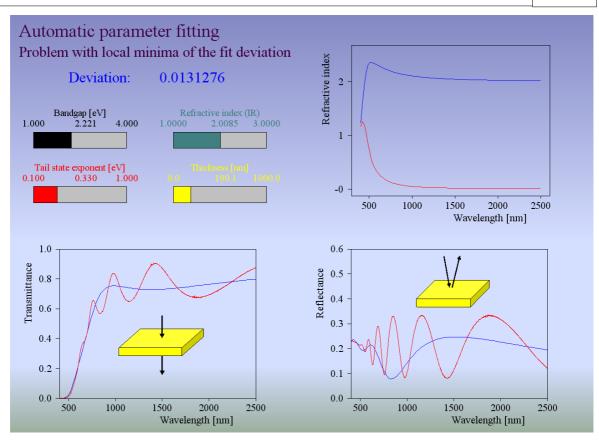
#### 3.3 Fit strategy

Once the optical model is ready, one must be decide which parameters may vary from sample to sample. These parameters must be determined following a fit strategy that leads to stable and reproducible results in the specified time frame.

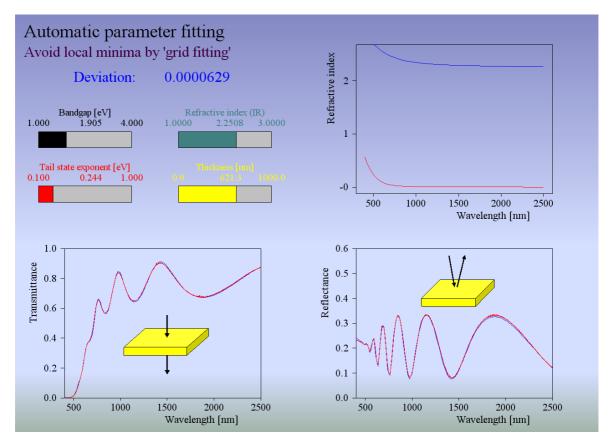
2. Development of the optical model Fit strategy				
How can we get correct results as fast as possible?				
Optimization of several parameters				
Production control: Finite time interval for analysis				
Conflict: Avoid local minima of the fit deviation <> speed				
Gain speed using				
Reasonable number of data points				
'Fit on a grid'				
Appropriate sequence of fit parameter sets				
	M Theiss Hard- and Software			
Developing optical production control methods for SCOUT	www.mtheiss.com			

Multiple parameter optimization is a common problem of numerical mathematics. One of the main issues is to avoid that algorithms get stuck in local minima of the fit deviation. Methods like simulated annealing or genetic algorithms which overcome the local minimum problem are much too slow to be used for production control.

Here is an example of a SCOUT fit running into a local fit deviation minimum: A start value of the layer thickness far away from the correct value drove the model into the wrong interference fringe order.



Using the 'grid fit' feature of SCOUT this problem can be overcome very efficiently: Before the multiple parameter fit is started, the right fringe order is found by trying several thickness values (equally spaced in a user-defined thickness range) and taking the best result as starting value for the thickness.



In many cases advanced fit strategies using so-called fit parameter sets are successful: Separate

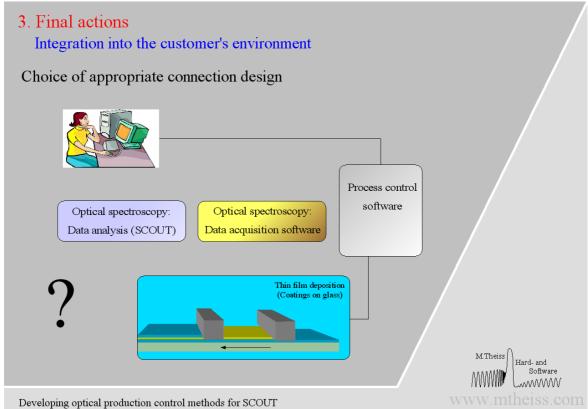
29

the fit parameters into groups which are optimized one after the other. You can, for example, fit the thickness and the refractive index of a material in a spectral region where the layer is transparent. Then freeze the parameters, and determine bandgap and other interband parameters in a spectral range with strong absorption. Then, in a final step, all parameters are optimized using the full width of the spectral data. Separating the problem into smaller pieces can speed up the optimization procedure significantly.

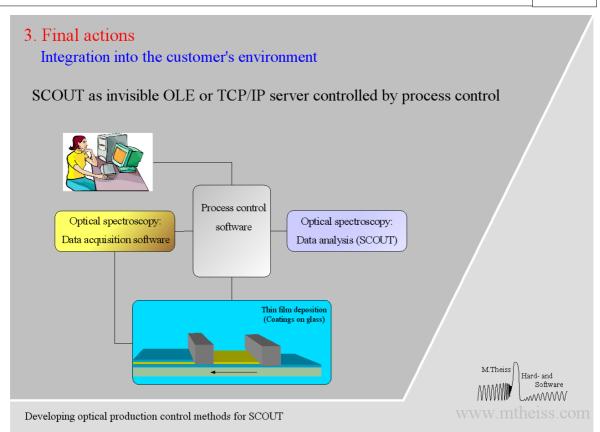
# 4 Final actions

#### 4.1 Integration into the customer's environment

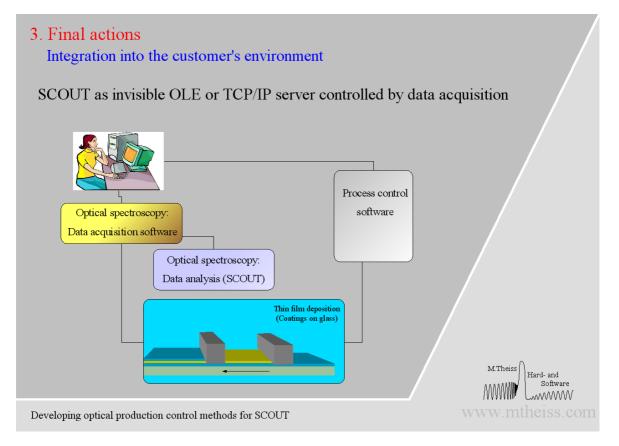
Now the method must be brought to the factory. The first question is how the various programs involved in the problem should be connected:



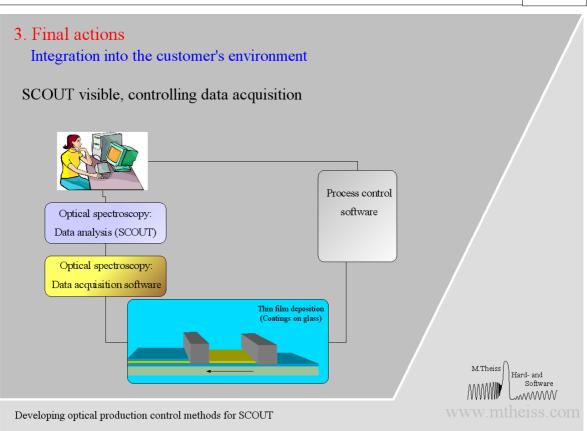
With SCOUT, several options are possible. The following example shows a configuration where both SCOUT and the data acquisition are controlled by the process control software. SCOUT can be accessed as OLE server or by TCP/IP communication.



The optical analysis can also be completely independent of the process control software:



SCOUT can also be used to control spectroscopic hardware and display results. In this case an appropriate user interface must be developed.



Once the decision concerning the factory configuration is made, the required hardware and software installations are to be done and the proper data exchange between all involved programs and computers must be established and verified.

# 4.2 Company tests and long-time support

Finally, the method must be tested and optimized in the plant during production. The long-time support contains the processing of error reports (bug fixing) and updates of the model and the user-interface.

3. Final actions Company tests and long time support	
Test function of each component Inspect fit quality achieved in the plant Adjust the speed of the analysis Instruct company employees	
Write the bill	
Process problem reports Discuss long-time behaviour of the results	
Developing optical production control methods for SCOUT	M. Theiss Hard- and Software MWWW WWW.mtheiss.com